

Title (en)

LOW DIELECTRIC GLASS COMPOSITION, FIBERS, AND ARTICLE

Title (de)

NIEDRIGDIELEKTRISCHE GLASZUSAMMENSETZUNG, FASERN UND ARTIKEL

Title (fr)

COMPOSITION DE VERRE À FAIBLE CONSTANCE DIÉLECTRIQUE, FIBRES ET ARTICLE

Publication

**EP 4085036 A1 20221109 (EN)**

Application

**EP 20909503 A 20201229**

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- US 2020067283 W 20201229

Abstract (en)

[origin: WO2021138295A1] Glass compositions and glass fibers having low dielectric constants and low dissipation factors that may be suitable for use in electronic applications and articles are disclosed. The glass fibers and compositions of the present invention may include between 48.0 to 57.0 weight percent SiO<sub>2</sub>; between 15.0 and 26.0 weight percent B<sub>2</sub>O<sub>3</sub>; between 12.0 and 18.0 weight percent Al<sub>2</sub>O<sub>3</sub>; between greater than 3.0 and 8.0 weight percent P<sub>2</sub>O<sub>5</sub>; between greater than 0.25 and 7.00 weight percent CaO; 5.0 or less weight percent MgO; and 6.0 or less weight percent TiO<sub>2</sub>. Further, the glass composition has a glass viscosity of 1000 poise at a temperature greater than 1350 degrees Celsius and a liquidus temperature greater than 1100 degrees Celsius.

IPC 8 full level

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